ESD Protection Diodes Silicon Epitaxial Planar

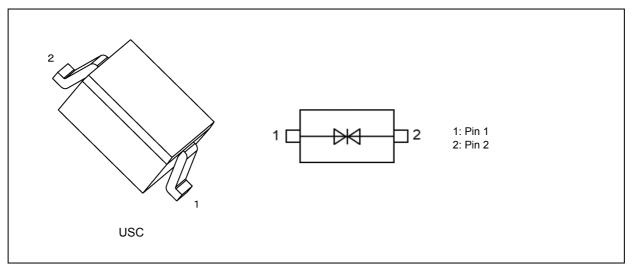
DF2B36FU

1. Applications

2. Features

(1) AEC-Q101 qualified (Please see the orderable part number list)

3. Packaging and Internal Circuit



4. Orderable part number

Orderable part number	AEC-Q101		Note		
DF2B36FU,H3F	_		General Use		
DF2B36FU,H3XGF	YES	(Note 1)	Unintended Use	(Note 1)	
DF2B36FU,H3XHF	YES		Automotive Use		

Note 1: For more information, please contact our sales or use the inquiry form on our website.

ESD Protection

Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

5. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25^{\circ}C$)

Characteristics	Symbol	Note	Rating	Unit
Electrostatic discharge voltage (IEC61000-4-2)(Contact)		(Note 1)	±20	kV
Electrostatic discharge voltage (IEC61000-4-2)(Air)				
Electrostatic discharge voltage (ISO10605)(Contact)	V _{ESD}	(Note 2)	±20	kV
Electrostatic discharge voltage (ISO10605)(Air)	1			
Peak pulse power (tp = 8/20 μs)	P _{PK}		150	W
Peak pulse current (tp = 8/20 μs)	I _{PP}	(Note 3)	2.5	А
Junction temperature	Тj		150	°C
Storage temperature	T _{stg}		-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: According to IEC61000-4-2.

Note 2: According to ISO10605. (@ C = 330 pF, R = 2 k Ω)

Note 3: According to IEC61000-4-5.

6. Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

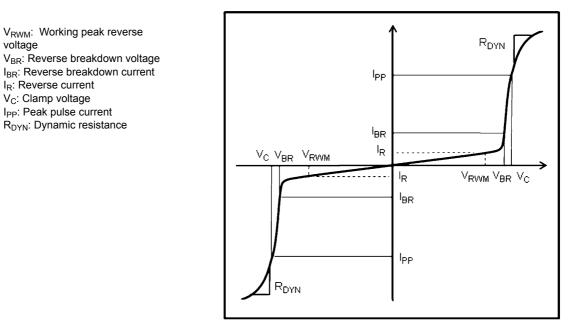


Fig. 6.1 Definitions of Electrical Characteristics

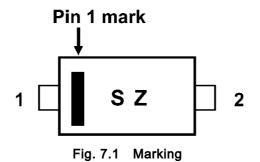
Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Working peak reverse voltage	V _{RWM}		_	—		28	V
Reverse breakdown voltage	V _{BR}		I _{BR} = 1 mA	32	36	40	V
Reverse current	I _R		V _{RWM} = 28 V	_		0.1	μΑ
Clamp voltage	V _C	(Note 1)	I _{PP} = 1 A	_	40	_	V
			I _{PP} = 2.5 A	_	50	60	
Dynamic resistance	R _{DYN}	(Note 2)	_	_	1.5	_	Ω
Total capacitance	Ct	(Note 3)	V _R = 0 V, f = 1 MHz	_	6.5	8	pF

Note 1: Based on IEC61000-4-5 8/20 μs pulse.

Note 2: TLP parameter: Z0 = 50 Ω , tp = 100 ns, tr = 300 ps, averaging window: t1 = 30 ns to t2 = 60 ns,

extraction of dynamic resistance using a least-squares fit of TLP characteristics at I_{PP} between 8 A to 16 A. Note 3: Guaranteed by design.

7. Marking



8. Land Pattern Dimensions (for reference only)

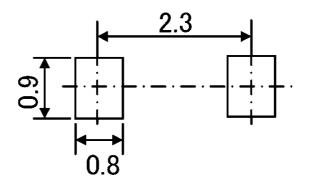
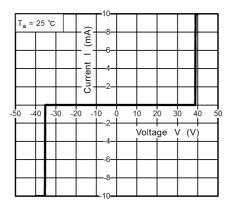


Fig. 8.1 Land Pattern Dimensions (Unit: mm)

9. Characteristics Curves (Note)



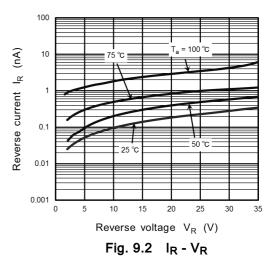
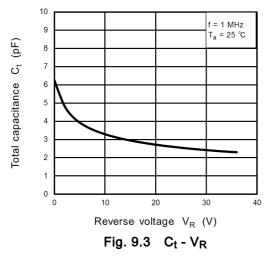


Fig. 9.1 I - V



Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

10. Clamp Voltage V_C - Peak Pulse Current (I_{PP}) (Note)

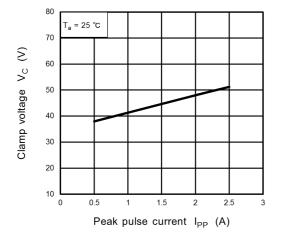
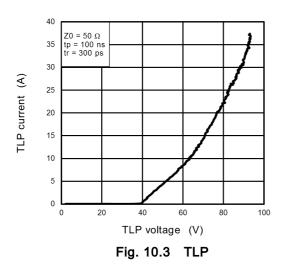


Fig. 10.1 V_C - I_{PP}



Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

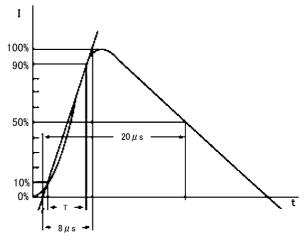
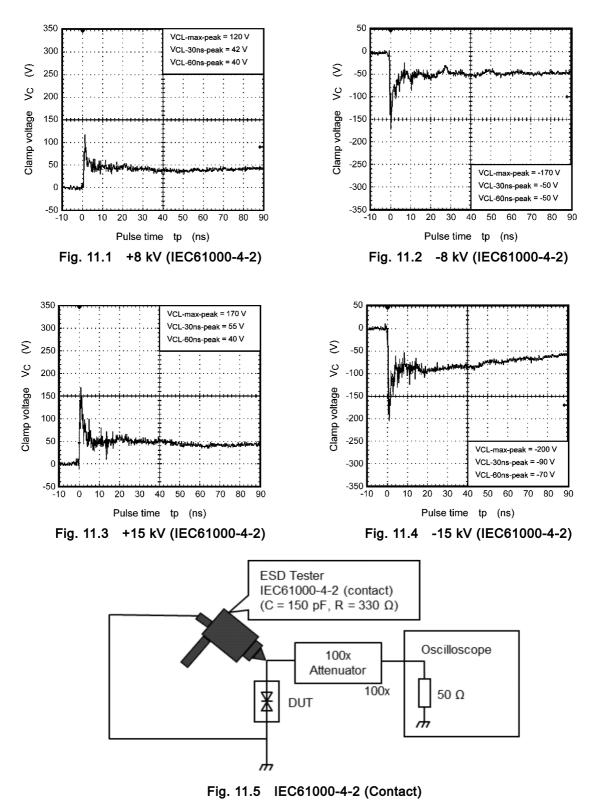


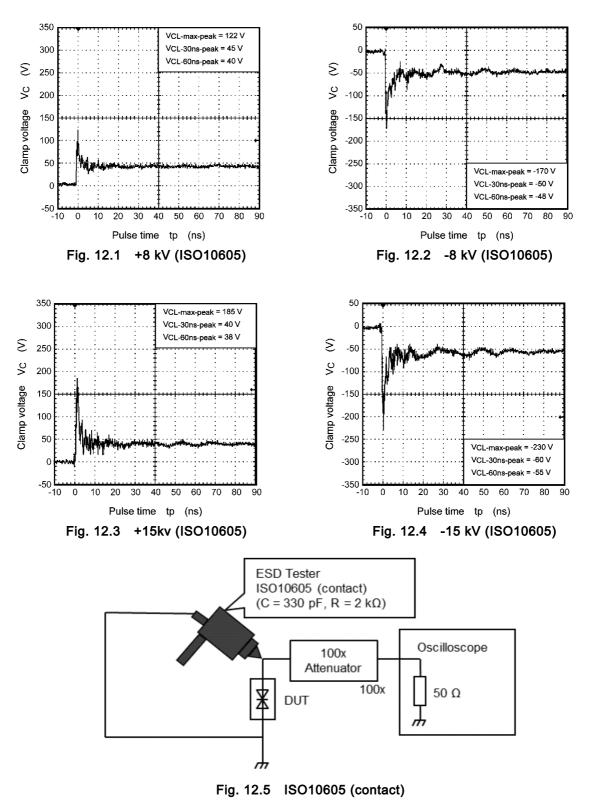
Fig. 10.2 Based on IEC61000-4-5 8/20 μs pulse. (Ed.2)

11. ESD Clamp Waveform (Note)



Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

12. ESD Clamp Waveform (Note)

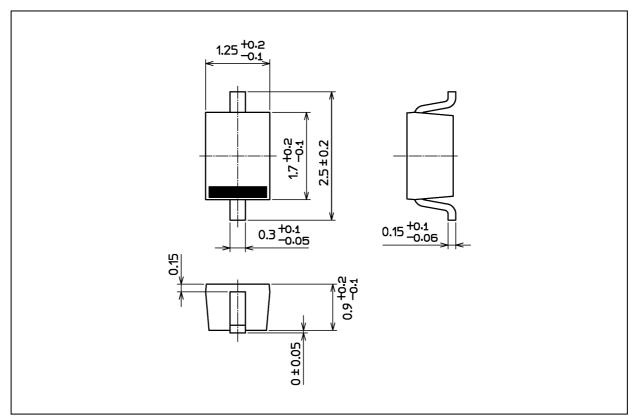


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

DF2B36FU

Package Dimensions

Unit: mm



Weight: 4.5 mg (typ.)

	Package Name(s)
Nickname: USC	

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